



MXi101V AMPLIFIER TECHNICAL SERVICE MANUAL



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MXI101V TECHNICAL SERVICE MANUAL

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2 SAFETY NOTICES

This section provides general guidance and information for the operation, maintenance, and service personnel who are familiar with the hazards of working with high-powered electronic circuits. This manual does not detail all of the safety precautions which should be observed when servicing this or any other electronic equipment. **Service by inadequately trained or inexperienced personnel can result in personal injury or death and/or damage to the equipment.**

Important: All personnel concerned with the servicing of this equipment should be thoroughly familiar with standard first aid procedures for the treatment of electrical burns and shock, including cardio-pulmonary resuscitation (CPR).

Use the “buddy” system, with one person performing the actual service and a colleague observing. The observer must be familiar with the work being performed and within sight and sound of the person doing the work. The observer should not be engaged in any other work or be otherwise distracted; he must be available **instantly** in case of accident.

Always have the observer with you when you work on the transmitter.

2.1 BERYLLIUM OXIDE WARNING

Internal thermal management in certain RF devices in this equipment is accomplished through the use of Beryllium Oxide ceramic material. Do not break open any RF power transistors, or otherwise dismantle them. Beryllium Oxide is a hard white ceramic used as insulation for heatsinking of RF power semiconductors. Beryllium Oxide is a **poison**. In case of accidental breakage of devices, **do not inhale the resulting beryllium dust and avoid getting beryllium dust in your mouth. Do not let beryllium into your blood stream through cuts or open wounds.** Seek **immediate** medical attention if the dust enters your body in any manner. Avoid cuts by wearing gloves while picking up the broken pieces. Be careful – do not inhale dust while replacing or emptying vacuum cleaner filter bags and wash your hands thoroughly afterward. Wash your hands thoroughly after replacing RF power devices. Dispose of defective RF power devices only through approved toxic waste facilities. Wear gloves when picking up the pieces. Wash your hands thoroughly after replacing devices. Dispose of defective devices only through approved toxic waste facilities.

When cleaning up after an accidental breakage, remember to wear a respirator mask to avoid inhaling the dust while replacing or emptying vacuum cleaner filter bags and to wash your hands well after servicing the vacuum cleaner. If possible, use a wet vacuum, in which the dust gets trapped in water.

2.2 OTHER TOXIC MATERIALS

The non-metallic coverings of some coaxial cables used in this equipment are **flammable** and can transmit fire when ignited. Other wire coverings are not capable of supporting combustion but any non-metallic covering when heated sufficiently can emit dense smoke and acid gases, which can be highly toxic and often corrosive.

Solvents and glues can emit toxic vapors and can be flammable. Read and understand the directions on the containers and ensure that they are used only in well ventilated locations.

2.3 DANGEROUS VOLTAGES

This equipment has been designed to protect operating personnel from accidental contact with dangerous voltages, by means of shields and covers. It is extremely important that any protective covering devices be kept in place at all times.

While all practical safety precautions have been adopted to safeguard personnel from possible injury, both supervisory and operating personnel are urged to ensure that the safety rules detailed below are followed as an established routine at all times. The following four Rules are the standard safety guidelines for working with and around transmitters.

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Rule #1 **KILL THE AC POWER BEFORE IT KILLS YOU**

Under no circumstances should any person reach within the cabinets for the purpose of servicing or adjusting the equipment without first disconnecting the AC power or without the immediate presence of another person capable of rendering aid. The "buddy" system is encouraged for transmitter work.

Rule #2 **DO NOT TAMPER WITH INTERLOCKS OR SAFETY SHIELDS**

Under normal circumstances, no safety shield should be removed.

Rule #3 **REMOVE PERSONAL JEWELRY WHEN WORKING ON THE EQUIPMENT**

The mains AC power to this transmitter can deliver high currents capable of melting metallic tools or personal jewelry, such as watch bands, bracelets, or rings. Accidental short circuits from such metallic objects can cause an explosive shower of molten metal which can result in serious personal injury.

Rule #4 **KNOW FIRST AID AND KEEP FIRST AID SUPPLIES AVAILABLE**

Illustrated first aid instructions for the treatment of electrical shock and burns and CPR procedures should be displayed in a prominent location adjacent to the equipment. In rendering first aid, the timeliness and effectiveness of the treatment are vitally important to the recovery of the injured person.

Always have a colleague with you when you work on the transmitter and make sure both of you know first aid, including cardio-pulmonary resuscitation (CPR). This is most important.

Without exception, all personnel should thoroughly familiarize themselves with the procedures involved. One person, whose normal duties place him or her at the transmitter site often, should be given complete responsibility and authority to ensure that first aid supplies are kept onsite and maintained. Prominently display a list of emergency phone numbers. This list should include the numbers of the nearest police, ambulance, hospital, doctor, fire department, paramedics, poison control center, public works (roads) department, and the utility (power and phone) companies.

Do not try to work on the transmitter if you are tired or drowsy; you could make a fatal error in judgment.

2.3.1 **Switch to Safety**

Here are some safety suggestions, based partially on the knowledge of experts familiar with high-powered tubed equipment, and partially on the procedures used at a typical utility company and at a company which makes and tests high voltage devices. A few of these suggestions apply primarily to factory environments and require some modification to be applied in transmitter settings.

Our thanks to the Varian Corporation for sharing its "Electrical Safety Training Program" notes. Our thanks also to Ontario Hydro for its information booklets dealing with high voltage.

Have in place a comprehensive safety program, with defined procedures. Know First Aid and CPR.

Use the "buddy" system, with one person performing the actual service and a colleague observing. The observer must be familiar with the work being performed and within sight and sound of the person doing the work. The observer should not be engaged in any other work or be otherwise distracted; he must be available **instantly** in case of accident. *Always have the observer with you when you work on the transmitter.*

Pay attention to emergency communications requirements. This could even include a voice channel on the STL so that constant communication with the studio can be maintained. Headset-equipped phones connected on this voice channel should be installed in locations near hazardous areas or everyone on site should carry fully charged cell phones. When you are administering CPR, you might not be able to leave your patient for the length of time it could take to call paramedics, especially if phone service is poor, or lines are down, and/or you are in a rural area without emergency telephone service (e.g., 911 in North America).

Do not defeat the interlock switches on access doors unless it is absolutely necessary and you know **exactly** what you are doing.

Keep the area neat and tidy, free of any interfering conductive material and free of any sharp objects. Remember that reaction to a shock could cause you to strike nearby objects.

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Avoid wearing loose clothing and personal jewelry such as rings, watches, and chains when working near energized circuits. Make a habit of removing all jewelry and storing it in a safe place as soon as you enter the transmitter building.

Before beginning work, **shut off all AC to the transmitter power supplies. Tag and lockout the switches.** Your safety routine must ensure that the person placing the tag and locking the switch is the only person who removes it and reactivates the switch. You might want to include the AC to the remote control as well, if there is any possibility that a studio worker could unknowingly activate the transmitter while you are working on it. One way of ensuring that the lockout "placer and remover" are the same person is to issue individual padlocks to each person on the transmitter technical staff.

You might want to include your tower contractor's rigging crew in the list of people who are allowed to use tags and padlocks. As an alternative, Dielectric™ makes a transmission line lockout switch that is intended for riggers to turn off and lock out any RF before climbing over the antenna to replace light bulbs, etc.

Proper grounding is **vital**. Make ground inspection a part of your maintenance program; someone's life could depend on it.

3 LARCAN PARTS, ASSEMBLIES, ASSEMBLY DRAWINGS AND SCHEMATIC NUMBERS

3.1 VENDOR STANDARD PART NUMBERS

Vendor or original manufacturer part numbers are indicated for most components.

3.2 LARCAN NUMBERS FOR PARTS, ASSEMBLIES AND DOCUMENTATION

An index of LARCAN specified number are used to define and specify the following:

- parts made by a manufacturer to LARCAN specification;
- an assembled unit or “group” such as a PC Board or completed cabinet;
- assembly drawings and schematics;
- standards.

Depending on the application, AutoCAD drawing or Microsoft Word document format is used.

Document numbers have the format **YYZXXXXKn Rev m** where:

YYZ Prefix denoting drawing size and Product type. Can be 10A, 11A, 20B, 21B, 30C, 31C, 40D, 41D, 50E, 51E
– describes drawing or document size, VHF or UHF application

XXXX Drawing Index number. Between 0000 to 9999.

K Refers to the type of drawing / document:

- “no suffix” for drawing of part (assembly or schematic)
- P = Part
- G = Group of parts
- A = Assembly drawing
- F = PC board fabrication films and
- S = Schematic

n Index number for drawing type. Part, group, assembly drawing or schematic next number and may be one or more digits

Rev Revision (sometimes denoted as R or R–)

m Revision number and may be one digit or more. May contain a decimal (e.g., Revision 3.2)

Drawings may consist of one or more sheets. Generally multiple sheets are used if one sheet is not enough to show all necessary information. Sometimes, especially with older drawings, multiple sheets are used to show more than one part or assembly.

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3.3 LEADED RESISTORS

Generic carbon composition resistors with leads are numbered as follows:

3R	□□□	P	nnnx - or - nnx	□
----	-----	---	-----------------------	---

<u>Power Rating</u>	<u>Resistance Value *</u>	<u>Tolerance</u>
152 = 1/4W	nn - first digits of resistance (5, 10% tol.)	K =10%
77 = 1/2W		J =5%
78 = 1W	nnn - first digits of resistance (1% tol.)	H =1%
79 = 2W	x - x10 multiplier	

For values between 1Ω and 10Ω, a letter “R” will appear in the resistance value to indicate the decimal place.

For vendor leaded resistors a generic drawing describing basic specifications, but having many “parts”, will often be used.

“3R152P5R6J” is 5.6Ω, 1/4W, ±5%

“3R152P470K” is 47Ω, 1/4W, ±10%

“3R152P1022H” is 10.2kΩ, 1/4W, ±1%

“3R152P102J” is 1kΩ, 1/4W, ±5%

3.4 SURFACE MOUNT RESISTORS 1/4W AND LESS

There is no specified recommended supplier of these parts. The Philips numbering system is employed with the following parameters/designations (example follows):

9C	□□□□	□	A	nnnx	□	□
----	------	---	---	------	---	---

<u>SIZE LxW</u>	<u>POWER RATING</u>	<u>RESISTANCE VALUE</u>	<u>TOLERANCE</u>	<u>TEMP COEF</u>
0603=1.6x08mm	1 = 1/16W	nnx tolerance>=5% nn=first 2 digits x=multiplier	D=0.5%	C=50ppm/°C
0805=2x1.25mm	2 = 1/10W		F=1%	K=100ppm/°C
1206=3.2x1.6mm	2 = 1/8W (1% tol.)	nnnx tolerance<5% nnn=first 3 digits x=multiplier	J=5%	L=200ppm/°C
	3 =1/4W (5% tol.)			M=300ppm/°C

nRnx or nnRnx or nRnnx
R inserted as decimal point
where required

0000 - four zeros for jumper

The pairs of parameters enclosed in boxes are normally mutually selected; for example, a resistor having 1% tolerance normally is selected as having a temperature coefficient of 100ppm/°C.

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Example: **9C08052A1001FK**

(Size 0805, Power Rating 1/10W, Resistance 1kohm, Tolerance 1%, Temperature Coefficient 100ppm/°C)

3.5 SURFACE MOUNT CAPACITORS

There is no specifically recommended supplier of these parts. The part numbering system being used is based on a Philips (now Yageo/Phycomp) numbering system with the following parameters/designations (example follows):

<u>SIZE LxW</u>	<u>DIELECTRIC MATERIAL</u>	<u>CAPACITANCE VALUE</u> (in Pico farads)	<u>TOLERANCE</u>	<u>VOLTAGE RATING</u>	<u>TERMINATION</u>
0603=1.6x08mm	CG = NPO	nn =first 2 digits	B=0.10pF	7=16VDC	B=Ni/Sn
0805=2x1.25mm	2R = X7R	x =multiplier as shown below	C=0.25pF	8=25VDC	A=Ag/Pd
1206=3.2x1.6mm	2F = Y5V *	8=x0.01	D=0.50pF	9=50 VDC	C=Ni/Sn-Pb
	2E = Z5U *	9=x0.1	F=1%	0=100VDC	
		0=x1	G=2%	B=200VDC	
		1=x10	J=5%	D=500VDC	
		2=x100	K=10%		
		3=x1000	M=20%		
		4=x10000			
		5=x100000			

* (infrequent use)

e.g., 0805CG102J9B

SIZE	=0805
DIELECTRIC MATERIAL	=NPO
VALUE	=1000pF
TOLERANCE	=5%
VOLTAGE RATING	=50V
TERMINATION	=Ni/Sn
PACKAGING	=Not Specified
MARKING	=None

Note that “u” appears in most cases instead of the correct symbol “μ” whenever a “micro” is required. Electronic parts list data, when imported by our PC publication program, allows us to substitute the correct “μ” when checking and editing.

3.6 PARTS LISTS

Parts lists for all assemblies in the transmitter are provided on CD-ROM, in PDF format. The CD-ROM is packed inside the transmitter cabinet for shipping.

Parts lists are generated in a hierarchical structure, beginning with major assemblies, then the subassemblies of each major assembly, and so forth.

3.6.1 Production Changes

From time to time, it may become necessary to make changes in the equipment described in this manual. Such changes are usually made either to provide improved performance or to accommodate component substitutions.

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A revision letter or number may follow the model or group number marked on the nameplate, chassis, or circuit board; or on the parts list (where it is an "R" followed by a dash and a number). Whenever a revision letter or number appears, it should be quoted in any communication regarding the equipment.

MXiV DUAL PALLET OPERATIONS AND MAINTENANCE

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1 MXi CONTROLLER

The MXi control board (Assembly 31C1897) is a single-circuit assembly that provides all of the control functions required for the MXi series of transmitters on a single circuit board. This board can be configured for a number of different transmitter types, power levels, transmission standards and options.



Figure 2 MXi Controller

The MXi control board provides local front panel interface via ON/OFF and RESET buttons as well as a graphical user interface through a front panel LCD assembly with touchpad for user commands. The board implements controls/status/telemetry for remote control through a rear panel connector that will interface to a typical remote control systems (such as Moseley or Gentner). An RS232 serial port is also provided to allow the operator to access the MXi through an external computer (with the appropriate software). The MXi control board has RF detectors for forward and reflected power and all the circuitry to support AGC/VSWR/Cutback functions. Circuitry to control and monitor the +50V power supply is also included on this board.



Figure 3 MXi Front Panel

The user interface to the amplifier is accomplished with the front panel LCD that incorporates a touchpad as an integral part of the unit. The LCD has the capability of displaying a variety of screens, which are selected by the user via the touchpad. Figure 4 shows the LCD main menu, which shows the present status of the amplifier along with the selections of submenus.

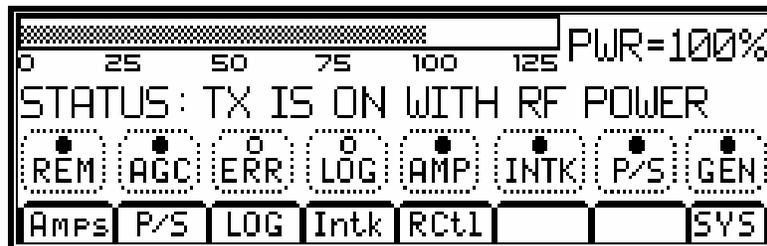


Figure 4 Main Menu Screen

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Forward (FWD) and Reflected power (RFL), AURal power, AGC and CUTBack (VSWR) control voltage, as well as the heatsink TEMPerature (Optional) can be displayed by selecting the AMP submenu as shown in Figure 5.

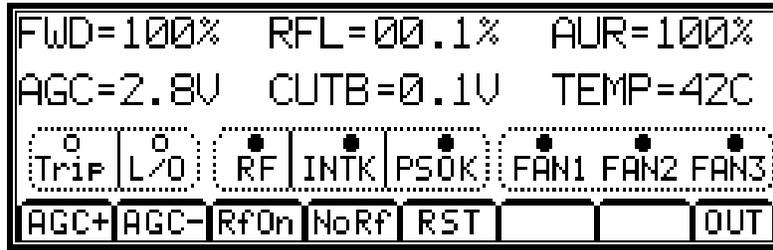


Figure 5 Amplifier (AMP) Submenu

Similarly, pressing the power supply P/S submenu from the Main Menu displays the power supply voltage and current consumption as well as its status.

For complete documentation regarding the Controller, see the publication *MXi Controller Board*.

2 AMPLIFIER INSTALLATION AND STARTUP

The MXi Amplifier was fully tested at LARCAN before it was delivered. Under normal circumstances, the transmitter can be fully operational with minimal setup when turned ON. However, a good practice is to take the “start from scratch” approach, which means that you should take precautionary measures before the amplifier is allowed to run at full rated power. These important steps will avoid any catastrophic failures at start-up. The procedure described is essentially the same approach taken at the factory with a new and untested transmitter. This also applies if there is a need to completely replace a major sub-assembly in the transmitter.

2.1 BEFORE APPLYING AC TO THE UNIT

Pay careful attention to items 1 to 3 before applying AC to the amplifier. These are initial steps that **must** be observed and followed for proper and safe operation of the amplifier.

1. Termination

- Ensure that the amplifier is properly terminated with a suitable load. This can be into a dummy load or into the transmitter output system. A 50 Ohm, 100W load with at least -20dB return loss (1.2 VSWR) is recommended. Preferably, directional couplers with known coupling levels at the frequency of interest should be connected at the input and output of the band-pass filter. These points are very useful in determining absolute power levels and losses and for use as an RF sample for monitoring purposes. See Figure 14 for a typical transmitter test equipment setup.

2. Interlocks

Interlocks must be connected to the amplifier to avoid damage to the equipment and to the output section. Interlock is provided at the INTERLOCK terminal board located on the rear panel. If this interlock is open, the +50V to the amplifier will shut down, including the cooling fans. DO NOT replace this interlock with a jumper.



Figure 6 Rear Panel Showing Interlock Terminal Board

3. Power At Minimum

- Initially, the Exciter or Channel Processor’s RF output should be at minimum level. Adjust the OUTPUT LEVEL control for a minimum output.

2.2 APPLYING AC TO THE UNIT

- Check that the AC voltage available to the amplifier ranges from 90-264VAC. If so, proceed to applying the power to the AC INPUT of the amplifier
- Once the AC is applied to the unit, the Control Power Supply turns ON and applies +12V to the MXi Controller.
- Observe that the Power-Up screen is displayed on the LCD, followed by the Main Menu.

MXiV DUAL PALLET OPERATIONS AND MAINTENANCE

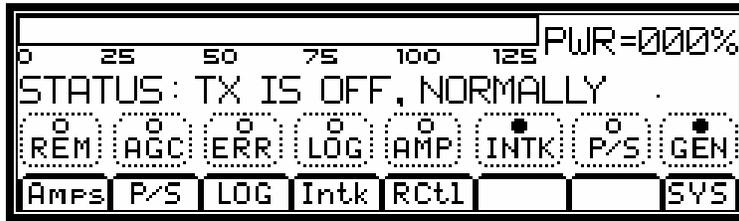


Figure 7 Main Menu

2.3 BEFORE TURNING THE AMPLIFIER ON

From the Main Menu, the status of the amplifier is displayed and shows if the amplifier is ready for operation. Status legends, when lit, such as the INTK (INTERLOCK), usually signify OK conditions and that the transmitter is ready to be turned ON.

Check that all of the following conditions are met:

1. EXCITER or Channel Processor is Ready.
 - Usually in the application of AC, the Exciter goes through its warm-up sequence. Ensure that it has done so.
2. POWER METERING is at Zero.
 - On the LCD (see Main Menu display in Figure 7), the PWR should be at 000% and the STATUS should be TX IS OFF, NORMALLY.
3. MXi CONTROLLER is ready.
 - If there were prior faults, clear them by pushing the RESET button.
4. INTERLOCKS are closed or OK.
 - Interlocks and Status are OK.

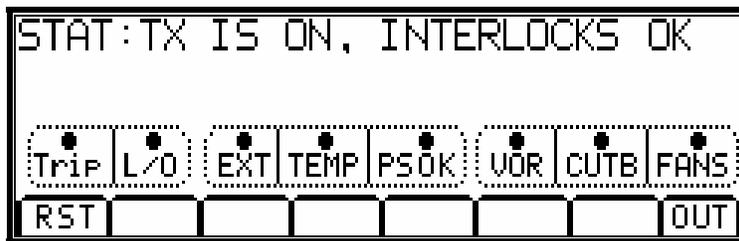


Figure 8 Interlocks Status

5. AGC control is DISABLED at this time.
 - Push the AGC button on the touchpad so that it is NOT selected.



Figure 9 AGC OFF

6. The Amplifier is in LOCAL mode.
 - Push the REM button so that it is NOT lit.
7. The TX is OFF.

MXiV DUAL PALLET OPERATIONS AND MAINTENANCE

- Push the Front Panel ON/OFF button so that it is NOT pushed in.

2.4 AMPLIFIER ON SEQUENCE

Upon depressing the ON button, the fans start and at the same time the +50V power supply is enabled, thus applying power to the MXi Amplifier. Since the Exciter or Channel Processor is on hot standby (RF is always applied), the amplifier normally produces output power immediately.

2.4.1 Turning ON MXi Amplifier

1. Enable amplifier LOCAL operation by pressing the REM touch button such that the REM legend is NOT lit.
 - Push the front panel ON button.
 - The MXi Amplifier should now be ON.



Figure 10 Transmitter ON

2. Monitor the +50V power supply voltage and current on the LCD. Check that the power supply is operating by pressing the P/S touch button. The voltage reading should be about 50V and the current should be about 3.0A under Static condition (no RF drive).

ALLOW THE AMPLIFIER SOME WARM-UP TIME!

Only after the transmitter has been ON for approximately 15 minutes should you perform the fine adjustments. The amplifier must be allowed to reach its operating temperature for stable and consistent operation. The Power Amplifier in the MXi transmitter is equipped with thermal compensation circuits, which reduce the output power when the temperature rises. Therefore, the operating temperature must be reached before adjusting the RF level to its proper level. The amplifier is also equipped with Automatic Gain Control, primarily designed to prevent the transmitter from overpower or overdrive condition.

3. Increase the RF output by slowly turning the Exciter or Channel Processor output level control. Stop at about 50% output power indicated on the LCD. At this level, the current should not be more than 6 Amps.
4. If the current is not abnormally high, increase the power to 100%. Again, make note of the PS current reading. This should not be more than 18 Amps.
5. AGC SETTING: With the AGC still disabled, increase the output power to 110%, using the output level control in the Exciter or Channel processor. Enable the AGC by pressing the AGC touch button until it lights. Use the LOWER button to set the power to 100%.
6. With the amplifier fully functional and adjusted to its final setting, record keeping becomes very important. Record the current, voltage, power, etc. This data can be used as a very valuable troubleshooting tool later. Below is typical test data pertaining to the MXi amplifier at 100% output power.

TYPICAL DATA read on the LCD

FWD	100%	CUTB	0.1V
RFL	00.1%	PS VOLTS	50.0V
AGC	1.0V	PS CURR	16A

3 TEST AND TROUBLESHOOTING

3.1 BASIC TROUBLESHOOTING TECHNIQUES

One of the best tools in troubleshooting is knowing what the nominal figures or typical values of the MXi amplifier when it is at its normal performance. If a fault condition occurs, then you can compare the data taken previously with the present conditions and come up with a reasonable conclusion about what is at fault.

The following describes some fault conditions and possible solutions.

3.1.1 Amplifier Completely OFF

The MXi amplifier is equipped with a fused AC line filter. Although it rarely happens, abnormal conditions such as power surges may cause the fuse to blow. A blown AC fuse will completely shutdown the amplifier, including a complete loss of information on the LCD touchpad. In this case, replacing the fuse will rectify the problem.

3.1.2 No RF Output

- Check for proper power supply voltage.
- Check for potential connector problems causing either no drive to a module pallet (input connector) or VSWR (output connector) problems.

3.1.3 Output Reduced to 25%

If the output is approximately 25%, a possible cause is a failure of one of the devices in the IPA or the PA amplifier module. These stages have dual devices so that if one fails the output of that stage will be reduced to quarter power (25%). A measurement of the current drawn by the amplifier will determine if this condition exists. The IPA usually draws 1A. If the current is 0.5, then this is the case. Similarly, the if one PA pallet draws either no current, or significantly less current than the other with no drive condition, then this is also the case.

MXiV DUAL PALLET OPERATIONS AND MAINTENANCE

4 MAINTENANCE

Equipment which is regularly and carefully maintained is far less likely to be subject to sudden failure than that which is operated without regard to basic maintenance requirements. A detailed preventive maintenance program should be established to ensure that the original efficiency and picture quality is maintained throughout the life of the equipment. Given reasonable care and attention, the transmitter will provide efficient and reliable service for many years.

Preventive maintenance techniques do not necessarily involve extensive dismantling of the various assemblies; on the contrary, this practice is to be discouraged unless a valid reason exists for doing so. Preventive maintenance is more directed at detailed physical inspection and the general observation of the equipment during and after operation, to detect the presence of any abnormality, which, if not corrected, might result in operational failure.

In preparing any maintenance program, the frequency and scope of the inspections must be determined and to a great degree will be influenced by site location and the station's market parameters and consequently its hours of operation, equipment configuration, and technical personnel deployment. For example, is the station on the air for 24 hours-a-day? Are there main/standby transmitters and are they attended or unattended?

In general, the following routines should form the basis of any maintenance program.

4.1 DAILY

At an attended site, the operator is afforded the opportunity to make frequent checks on the equipment and thereby increase his/her familiarity with its operation. The transmitter log entries made during these checks would include all meter readings, also any irregularity in performance or in picture quality, for later analysis. An unattended site where equipment is operated by remote control and monitored by telemetry and a high quality off-air receiver or demodulator can also be continuously checked for performance by studio technical personnel.

4.2 MONTHLY

In addition to the normal operational tests, thorough physical inspection of every piece of equipment should be made, with all power turned off. All surfaces should be dusted off or wiped down, terminal boards checked for loose connections, and all components examined for any evidence of overheating. High-pressure air, not over 20psi, can be used with discretion to dislodge dust from inaccessible places.

4.3 SEMI-ANNUALLY AND ANNUALLY

Check all external RF connections for tightness, looking specifically for any discoloration, which might indicate a loose inner connector, flange or sleeve coupling. Test the passive RF system with a transmission test set or network analyzer, if one is available, to identify any potential problems with the antenna or line. Inspect and clean contacts on all switches and contactors; carefully redress contact surfaces if pitted.

Check the operation of all interlocks including patch panel, dummy load, air and thermal switches and emergency interlocks (if applicable).

4.4 TRANSMITTER COOLING SYSTEM

All cooling fans in the transmitter are fitted with sealed bearings requiring no lubrication during the lifetime of the motor. Access to the blower assembly is via the top of the transmitter.

MXiV DUAL PALLET OPERATIONS AND MAINTENANCE

5 SERVICE

The MXi contains few user-serviceable parts; the modular surface-mount design makes module replacement and/or factory repair the most efficient repair method.

The service most likely to be performed by users is the replacement of the fan array.

5.1 REMOVING THE FAN ARRAY

The MXi fan array consists of four 4" muffin-type fans which are attached to the mounting plate. The mounting plate is secured to the bottom of the MXi chassis with three Phillips head screws.

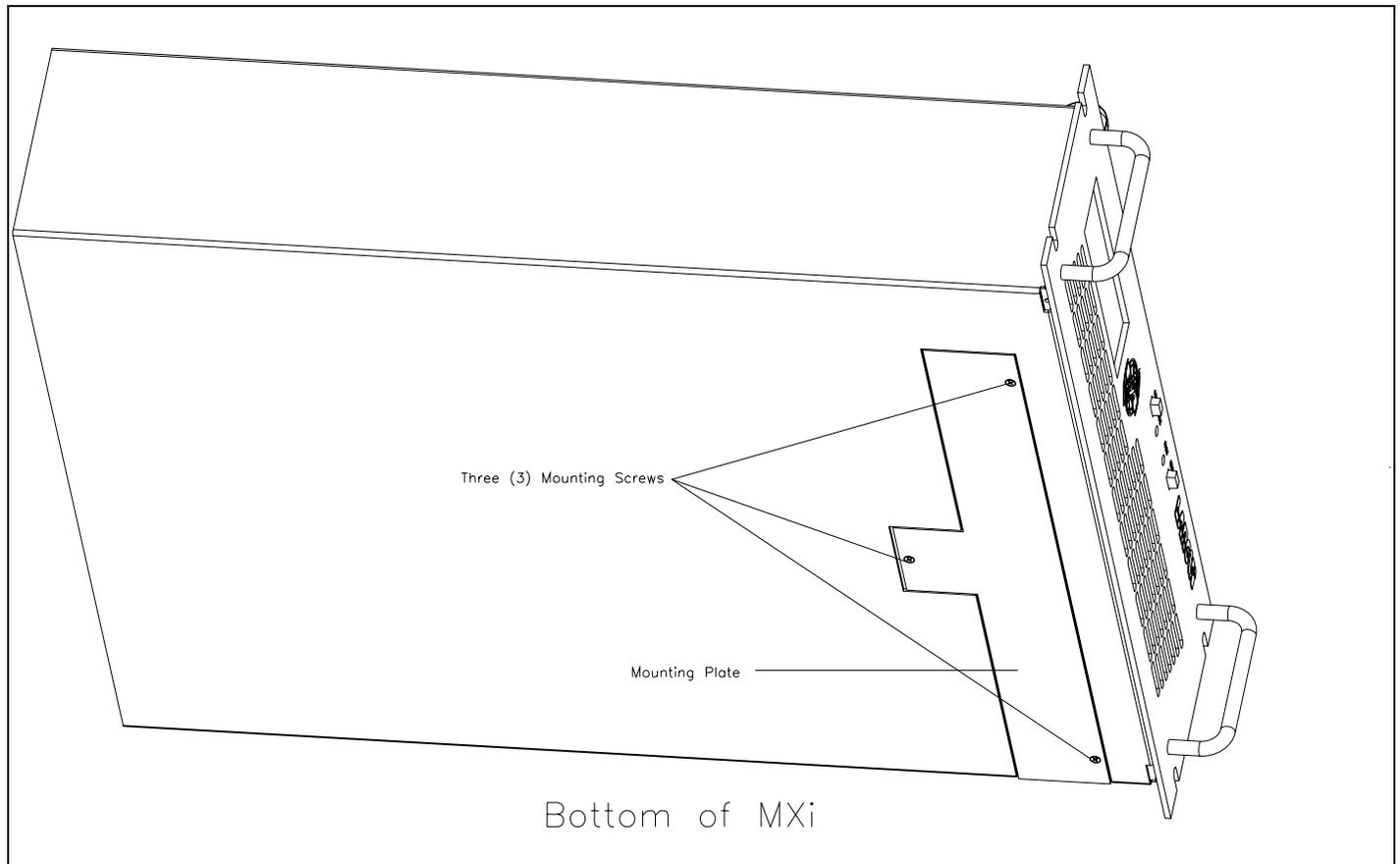


Figure 11 Bottom View of MXi

1. Turn the MXi OFF.
2. Disconnect the AC power from the MXi.
3. Slide the MXi partially out from the mounting rack. **Important:** Ensure that the weight of the MXi is fully supported.
4. With a Phillips screwdriver, remove the three mounting screws on the underside of the MXi. When removing the last screw, be sure to hold the mounting plate in place.
5. Remove the mounting plate. The fan array is attached to the mounting plate and comes out with the plate.

MXiV DUAL PALLET OPERATIONS AND MAINTENANCE



Figure 12 Fan Array

5.2 REPLACING THE ENTIRE FAN ARRAY

In the event of a fan failure, LARCAN recommends replacing the entire array, as all fans have a similar lifespan.

1. Remove the fan array as described in Section 5.1.
2. Slide the new fan array into the MXi. The power connection is aligned so that it connects when the mounting plate is fully in place.
3. Insert and tighten the five mounting screws. **Note:** Screws only need to be snug; do not overtighten.

5.3 REPLACING A SINGLE FAN

1. Remove the fan array as described in Section 5.1.
2. Each of the four fans is attached to the mounting plate via two screw-and-nut assemblies. Remove the screws and nuts and set aside.

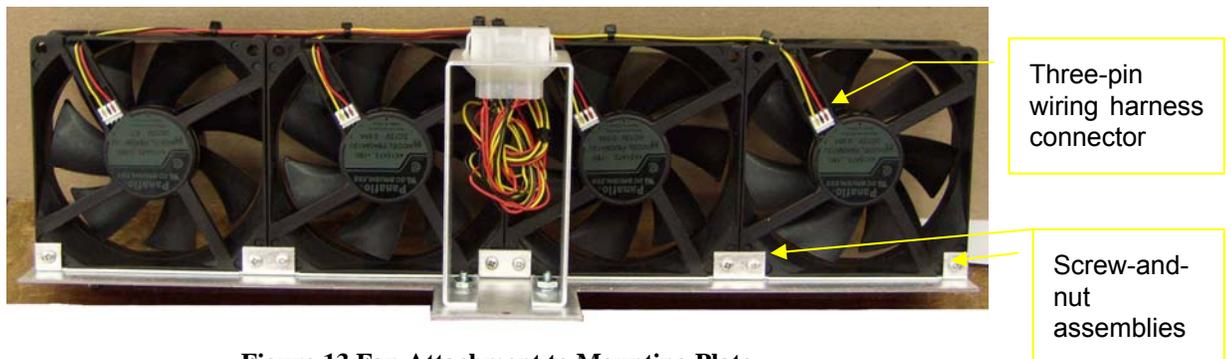


Figure 13 Fan Attachment to Mounting Plate

3. Disconnect the three-pin wiring harness connection by *gently* sliding it back with a fingernail or small plastic tool.
4. If necessary, carefully cut and remove the zip tie holding the wires to the fan frame.
5. Remove the defective fan and replace with a known good fan of *exactly* the same dimensions and specifications.
6. Re-connect the three-pin wiring harness connection.
7. Re-fasten the two screw-and-nut assemblies holding the fan to the mounting plate.
8. If necessary, replace the zip tie holding the wires to the fan frame.
9. Replace fan array into MXi as described in Section 5.1.

6 TEST EQUIPMENT SETUP

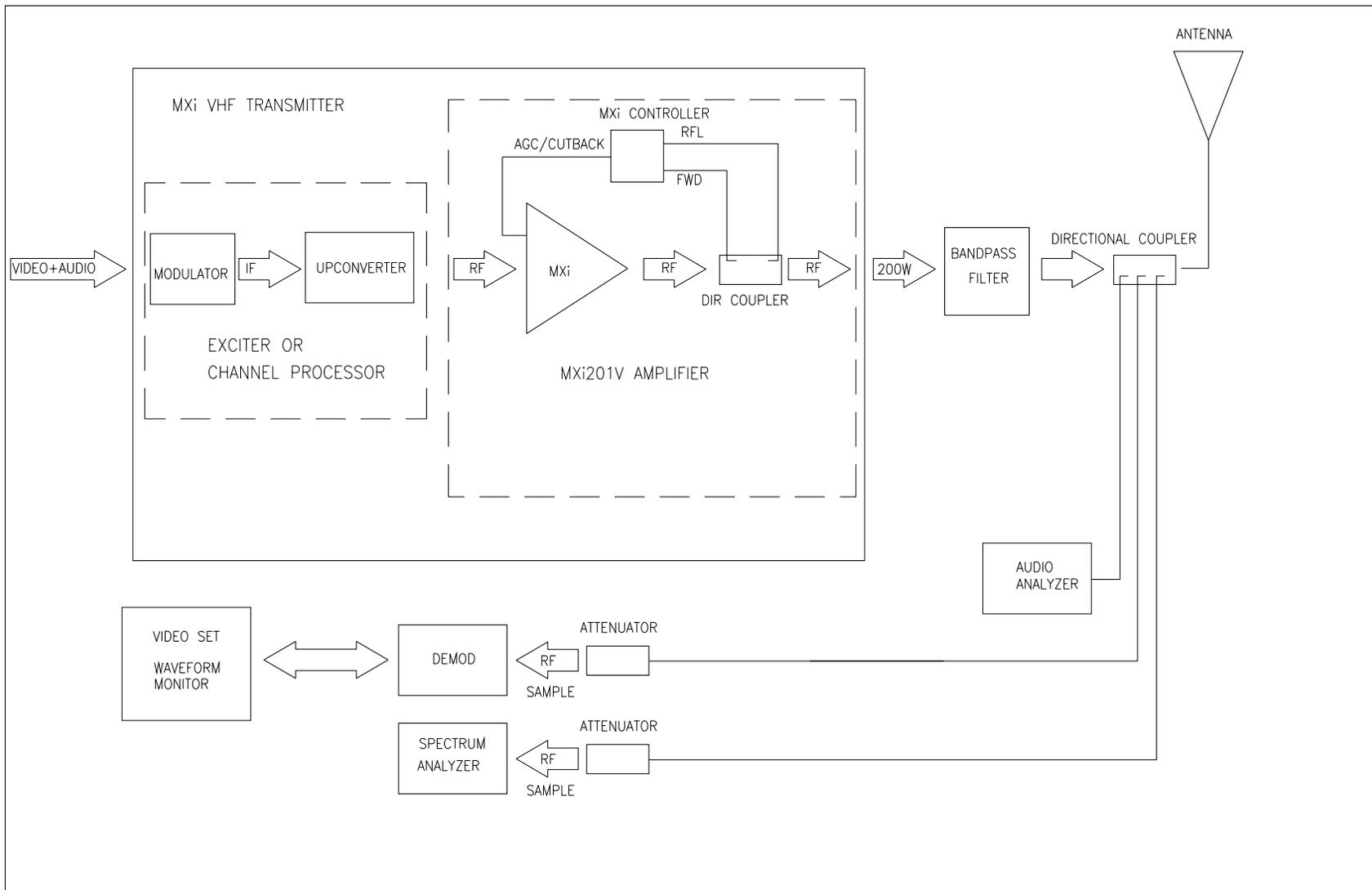


Figure 14 Test Equipment Setup

MXi DUAL PALLET OPERATIONS AND MAINTENANCE

7 SPECIFICATIONS

Specifications are subject to change without notice.

7.1 ELECTRICAL

AC Line Input90 to 264VAC, 50 to 60Hz
Power Consumption, black picture + 10% aural 500VA (typical)

7.2 ENVIRONMENTAL

Ambient Temperature0°C to +45°C (0°F to 113°F)
Humidity 0% to 90%
Altitude 2286 m (7500 ft.)

7.3 COOLING

Four 4" muffin fans push air through the heatsink and through the rear panel perforations.

7.4 DIMENSIONS

The Amplifier and Channel Processor chassis are standard 19" rack wide units.

Height

Amplifier.....	5.25" (3RU)
Exciter or Channel Processor.....	1.75" (1RU)
Total Height	7.00" (4RU)

Depth is 25" including a 3" allowance for connectors.

7.5 SHIPPING WEIGHT

WeightApproximately 14kg (31lbs.)

MXi AMPLIFIER CHASSIS

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MXi AMPLIFIER CHASSIS

1 MXi VHF AMPLIFIER

The MXi VHF Amplifier Chassis Assembly consists of a standard 19" rack mountable 5.25" (3RU) enclosure containing the amplifier heatsink assembly, a fan array assembly consisting of four DC cooling fans, a controller board with built-in RF detectors, and a front panel consisting of ON/OFF, RESET switches and an LCD/Touchpad, and a rear panel assembly with connectors for interfacing to external equipment. A dual output DC power supply for powering the amplifier, the controller and the cooling fans is also housed in this enclosure. Figure 15 is a front view of the MXi101V amplifier, showing the LCD Touchpad, ON/OFF switch, Status PWR (Green) and FAULT (Red) LEDs, and RESET switch.



Figure 15 Front View of MXi Amplifier



Figure 16 Rear View of MXi Amplifier

The rear of the MXi AMPLIFIER has the following connectors (from left to right):

- RF IN SMA connector-
- RF OUT N connector
- RF TP SMA connector – RF sample
- REMOTE CONTROL 15-pin D-shell connector
- RS232 SERIAL nine-pin connector
- INTERLOCK terminal board
- AC INPUT

The MXi is classified as a broadband amplifier, thus it is operational to cover the entire VHF television spectrum in three bands comprising ATSC channels 2 through 4, 5 through 6 and channels 7 through 13.

Controlled DC power to the amplifier assembly comes from the high efficiency 1000W switching power supply via a two-pin connector, J4 of the MXi Controller Board. Regulated DC of +50V from the switching power supply is the B+ voltage to the amplifier heatsink assembly. The second auxiliary output of the power supply is +12VDC, which is used for powering the controller and the cooling fans.

The heatsink cooling fans are the +12DC, 4-inch muffin model. Typically, they come ON at the same time B+ is applied to the power amplifier. It is connected to the controller PC board connector, J8. As built, the cooling fans

MXi AMPLIFIER CHASSIS

push air from the front panel through the heatsink and through the perforations in the rear panel. This assembly is located underneath the MXi Controller board.



Figure 17 MXi Fan Array

A thermal switch is mounted on the heatsink where the operating temperature is sensed. If this temperature increases beyond the trip point of the thermal switch, which is about 60°C, its contact opens and breaks the interlocking circuit of the MXi amplifier. The interlock circuit ultimately controls the power supply to the power amplifier and therefore shuts down and remains OFF until the heatsink cools down to about 50°C.

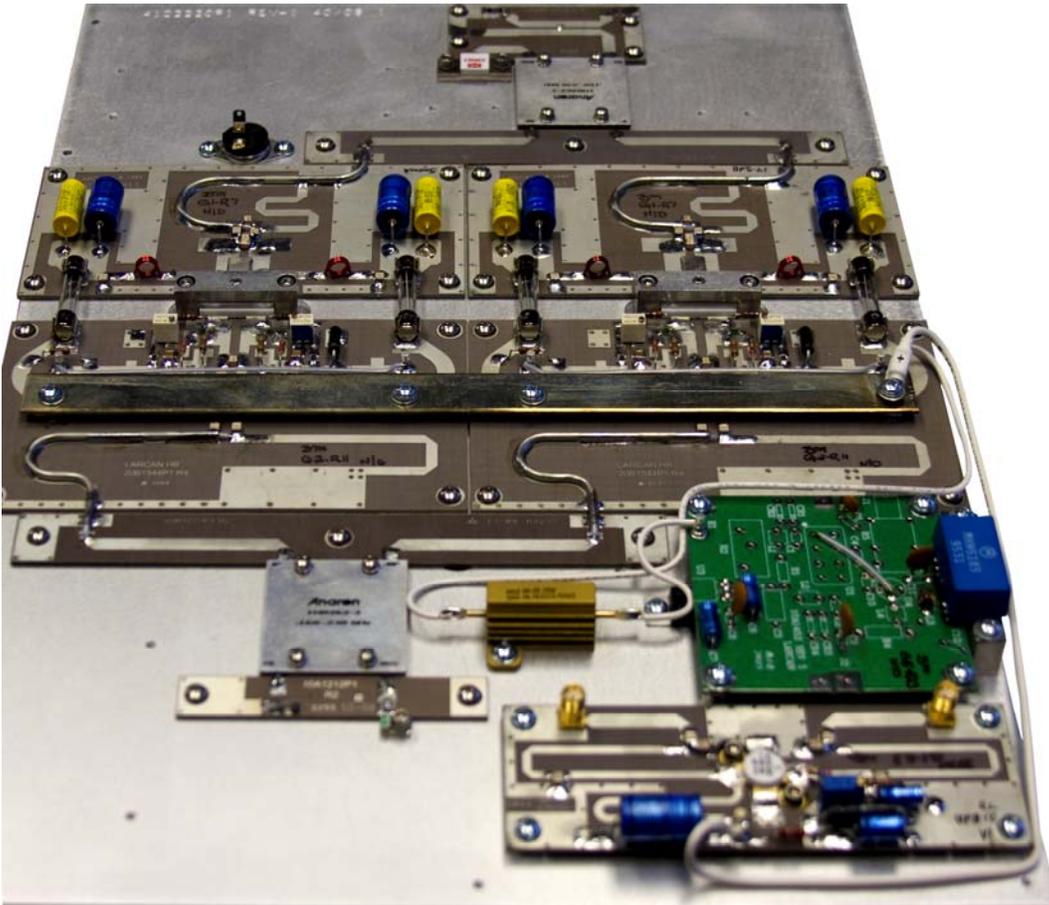


Figure 18 MXi Heatsink Assembly

A directional coupler is also mounted on the heatsink and provides forward and reflected RF signals to the controller. These RF samples are detected and processed on the MXi amplifier controller to provide DC outputs corresponding to these signals. They are then used for AGC, VSWR supervision and also for providing digital metering available on the front panel LCD touchpad.

POWER AMPLIFIER HEATSINK ASSEMBLY

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POWER AMPLIFIER HEATSINK ASSEMBLY

1 FUNCTIONAL DESCRIPTION:

The Power Amplifier heatsink assembly consists of a preamplifier driving a four-way power splitter, four 250W FET amplifiers, a four-way power combiner. A full-size heatsink provides the cooling for the active devices. It is designed for High Band 174 - 230 MHz television systems, and provides power gain of approximately 15 - 16 dB, with 1 kW peak sync visual or 600 W aural output. The module can provide upwards of 200W of average digital power when used with appropriate predistortion.

2 RF PREAMPLIFIER

High Band preamps 10A1453G1, used in higher powered transmitter service, have a type MWA130 instead of an MWA330 for U4. Specified gain of an MWA130 is approximately 12dB.

At the output of U2, a match to 50Ω is provided by C12 and the device lead inductance. These together create a low pass matching network in boards where a type CA2885 amplifier is used; conversely a type MHW6185 device characteristics give it a wideband match to 50Ω therefore no special output matching is necessary, and C12 is not present.

U3 is a voltage regulator providing +24 V to the preamplifier stage(s).

3 POWER AMPLIFIER:

The output amplifier consists of a single, source grounded, N-channel, insulated gate Field Effect Transistors (FETs) packaged in a single case and operating Class AB in a push-pull configuration. Because these FETs are "enhancement mode" devices, they require a positive gate-to-source bias voltage on each gate to cause source-drain conduction. The quiescent Class AB idling bias current is set independently for each half. The threshold gate voltage required to produce this idling current is typically may vary between 2V and 5V. Gate voltage thresholds in FETs also are temperature sensitive, so thermal compensation is provided by thermistor elements RT1 and RT2. Bias current is set to 500mA per half of the device for analog operation and 750mA per half for digital operation.

Gate bias is supplied from an adjustable voltage divider from the +39 V regulated bias rail. Resistors R1, R2, R3, R4 provide gate bias for one half of the amplifier; R5, R6, R7, R8 provide bias for the other half.

The RF input signal is applied to balun T1/L1 to provide two signals 180° out of phase. These signals are stepped down to match the low input impedance of the FET through a double L- π -network consisting of C1, C2, L2, L3, C7, and the gate capacitances of the FET, and then applied to the gates. The gate input impedance at the operating frequency is very low by comparison with the values of R3 and R6, so these resistors have little or no effect at RF.

R3 and R6 provide a DC path for bias, and provide loading at lower frequencies in order to assist in maintaining amplifier stability. The choice of C4 and C5 values, and their internal equivalent series inductances, also ensures effective bypassing at all frequencies.

The output matching double π -network, consisting of inductors L4 thru L10, and capacitances C12 thru C15, tunes out the FET drain capacitance and transforms the very low output impedance of the FET to 12.5 ohms. The two antiphase output signals, Push and Pull, are combined in balun T2, L11.

DC is applied to the drains through L4, L5 for the first half, and L6, L7 for the other half. L5 and L6 are also short sections of microstrip transmission line which transform the apparent RF impedances of L4 and L7 to more effective values as seen by the FET. RF and lower frequencies are bypassed with C3, C8, C9, and C6, C10, C11.

These groups of capacitors are selected in value and for their internal equivalent series inductances so that they will be an effective bypass at all frequencies of interest including video, to assist in maintaining amplifier stability. Towards this objective of stability: inductance L9, in addition to resonating with the FET output capacitance in the

POWER AMPLIFIER HEATSINK ASSEMBLY

operating frequency band, also is equivalent to a dead short at lower frequencies where it loads the device so heavily so that the stage will not become unstable.

Note that fuses are provided for the voltage supplied to the FET drain connections. The intent of these fuses is to protect the surrounding circuitry in the event of a device failure. The normal failure mode of active devices such as these is short-circuit, and the fuse will blow in this case, isolating the defective device from the rest of the module and transmitter power supply, allowing the remaining devices to keep operating normally. A blown fuse can serve as a valuable troubleshooting aid, when trying to identify failed devices.

4 ADJUSTMENT OF BIAS VOLTAGE TO ESTABLISH PROPER QUIESCENT FET BIAS CURRENT:

Important: 50 Ω input *and* output terminations are necessary to achieve consistent results and prevent damage to the devices when testing modules. Supplemental cooling is not required when performing bias adjustments or low power sweep of the PA modules.

1. Remove **all** fuses from the module to be tested. (There are 8 fuses in total).
2. Adjust all bias pots to maximum resistance, for minimum bias voltage. (Again, there are 8).
3. Use a clip lead to short the junction of C5, R6, and R7 to ground. This shuts off side B of the amplifier so it will not interfere (thru L9) with measurement of quiescent current from side A.
4. Terminate the RF input and output into a 50 Ω load.
5. Apply +50VDC from the front panel test point on the transmitter, through an ammeter, to the positive copper bus bar, and its negative to chassis. **Caution:** Observe polarity!
6. Check the voltage on the bias terminals, it should be 39 V \pm 2 V. (The bias terminals are connected together via insulated bus wire).
7. Read the current drawn by the VSWR board and bias regulator. Next, install a fuse in side A (nearest the panel) of amplifier #1; adjust the corresponding bias pot for a 500 mA increase in the power supply current; this increase corresponds to an idling bias current of 0.5 A. Remove the fuse. Remove the side B bias short and place it on side A at the junction of C6, R2, R3 and R9. Place the fuse in side B. Adjust the side B bias pot for the proper current.
8. Move the fuse to the remaining fuse holders, one at a time, and adjust each companion bias potentiometer in the same manner for the proper bias current.
9. Install remaining fuses and remove the bias short after all bias adjustments have been made.

POWER AMPLIFIER HEATSINK ASSEMBLY

6 LOW POWER SWEEP AMPLIFIERS

Note: Low power sweep of PA modules should not be required under normal circumstances – even when replacing FET devices. There are no tuning adjustments on these modules.

1. Ensure that terminations are in place in the test setup. All modules require 50 Ω source and load impedances to prevent damage and for consistent results during testing.
2. Connect the module to a sweep system, typically as shown in Figure 1. The sweep generator should be adjusted to give a linear sweep from 160 to 240 MHz so that all of High Band or Band III is swept, with a small amount of out-of-band signal on both ends.
3. Connect the lab power supply +50 V to the positive supply bus bar, and the negative to the chassis of the amplifier. The current should be limited to 7 or 8 A for this test. **Caution:** observe polarity!
4. With the power supply switched on, the current drawn should be not more than the bias current for all the devices together - about 4 amperes (8 x 0.5 A) for the PA module.

The swept in-band frequency response, for High Band modules, should be essentially flat within ± 1 dB as shown in Figure 1, with gain approximately 15 to 16dB.

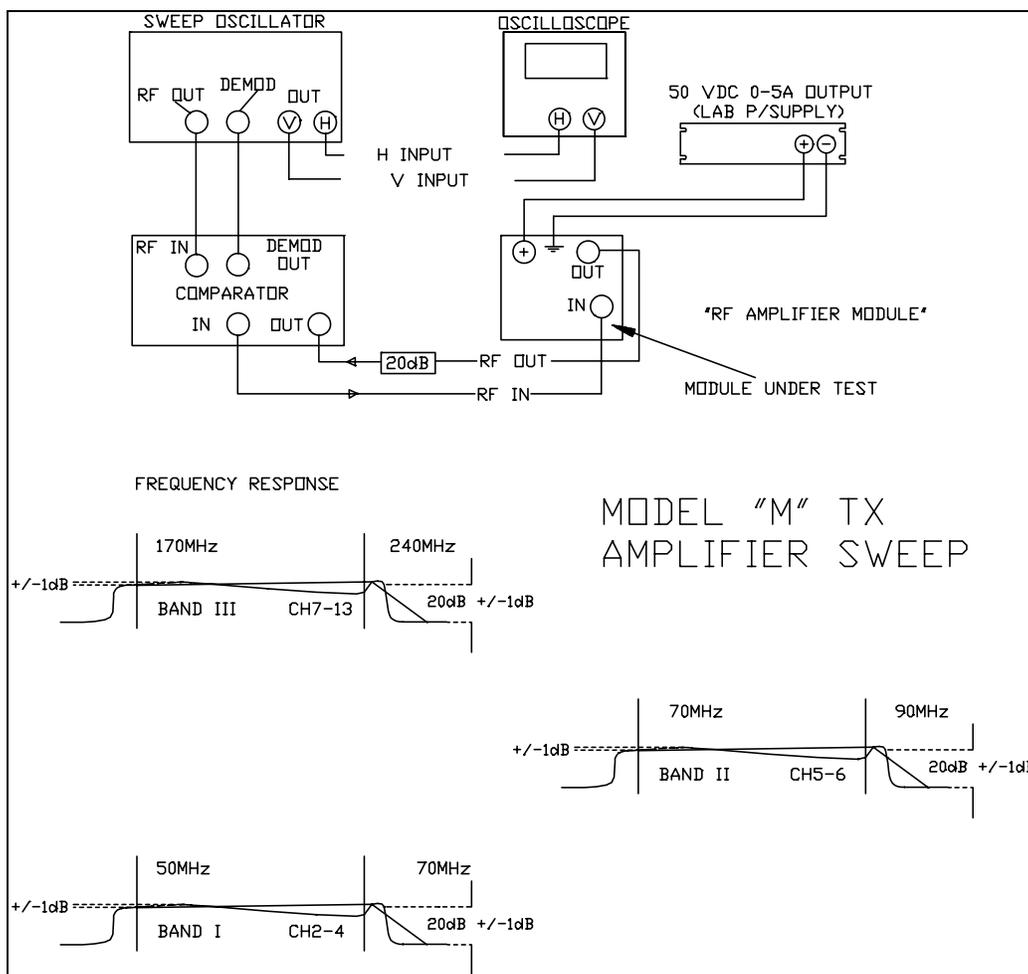


Figure 19 Module Sweep Setup

MXi 50V 1KW POWER SUPPLY

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MXi 50V 1KW POWER SUPPLY

1 MXi POWER SUPPLY LAR1000-50-P5337

The LAR1000-50-P5337 power supply used in the MXi Dual Pallet VHF amplifier is a free-standing, power factor corrected 1000W unit. It has the capability to deliver up to 20A when the power supply output is set to +50VDC. The design of this unit results in a highly efficient power supply ideal for the MXi dual pallet power level. This unit also contains an internal auxiliary 12VDC power supply rated at 3A which is used to provide power to the MXi Controller board as well as supplying power to the cooling fans. This auxiliary power supply provides +12VDC output as long as the main AC input is present.



Figure 20 MXi 1000W Power Supply

A 12-terminal interface board is used in the power supply for interfacing to various sub-assemblies in the MXi enclosure. The following describes the function of each terminal.

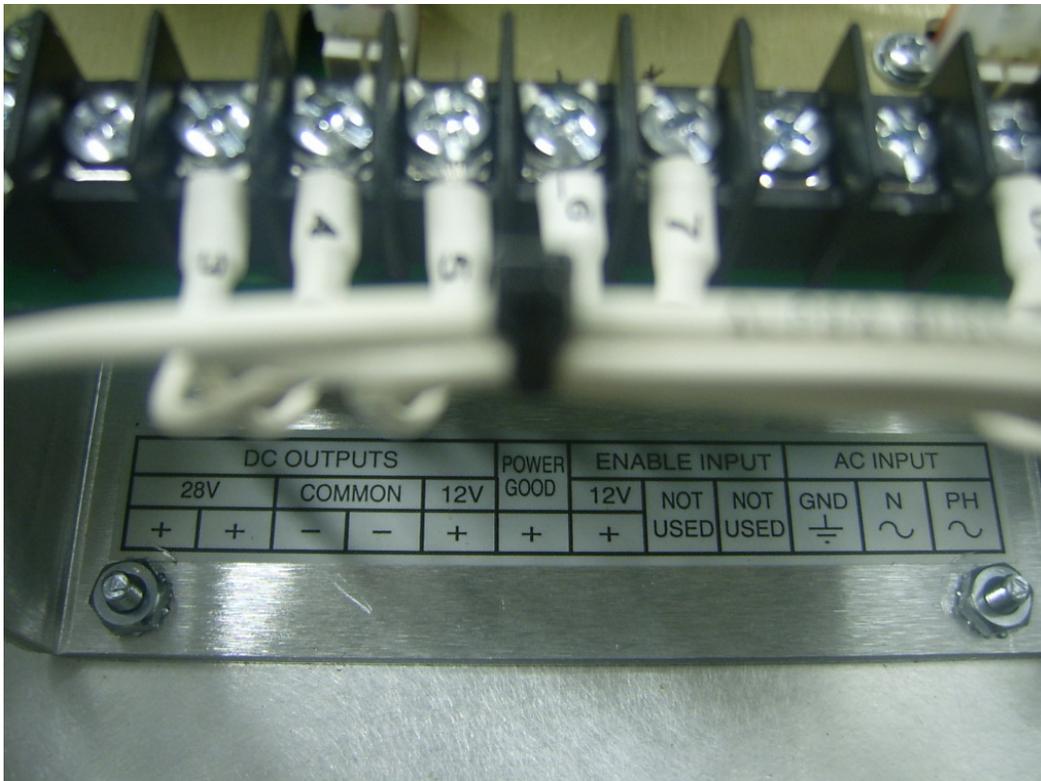


Figure 21 12-Terminal Interface Board

MXi 50V 1KW POWER SUPPLY

<u>TERMINAL/DESCRIPTION</u>	<u>FUNCTION</u>
1. +50VDC OUTPUT	First of two +50VDC outputs of the power supply
2. +50VDC OUTPUT	Second of two +50VDC outputs of the power supply
3. COMMON	(-) return of the 50V and 12V power supply
4. COMMON	(-) return of the 50V and 12V power supply
5. +12VDC OUTPUT	+12VDC for powering the MXi controller
6. POWER GOOD	A High (+12V) is measured here if the +50V power supply is OK
7. +12V ENABLE INPUT	If +12V is applied here, it will turn ON the +50VDC power supply. This enable signal comes from the MXi controller board provided the interlocks are closed and there are no fault conditions.
8. NOT USED	
9. NOT USED	
10. GND	AC GND
11. N	AC Neutral
12. PH	AC Phase (Line)

MXi 50V 1KW POWER SUPPLY

2 POWER SUPPLY DATA SHEET REPRINT

The following is a reprint of the LAR1000-50-P5337 switching power supply data sheet, with permission from Absopulse Electronics Ltd.

MXi 50V 1KW POWER SUPPLY

Model: LAR1000-32-P5337
OSD: 1428 0991, 1337 0397SP6 **COSD:** G099-1
Summary Description: Power Supply with PFC Input and Double Outputs 32V/31A; 12V/3A
Customer Name: Larcan
Customer Part Number: Same as above



The unit is built with a combination of a custom LAR1000 unit (LAR500 chassis is used) and an MIW100 module. It is in a custom 5.25"x4.25"x14.25" enclosure. There are four, clear mounting holes on the chassis.

The MIW100 module provides an independent 12V output, which is always ON if the unit has AC input power. The 32V main output is ON, when the enable terminal is connected to the +12V. A Power Good comparator monitors the 32V output and provides a +12V signal when the output is within the tolerance range. The cooling is via forced air provided by the customer's external fan.

SPECIFICATIONS

Input Voltage

90-264VAC universal
 47-63Hz
 Input current: 16Arms max.

Input Protection

Inrush current limiting by NTC surgestor
 Internal safety fuse.
 Varistor S14K275
 Lower voltage than the specified minimum input will not damage the unit

Input Power Factor:

Min. 0.98 at full load for the entire input range. Meets EN61000-3-2.

Isolation

2250VDC input to chassis
 4300VDC input to output
 8mm spacing
 500VDC output to chassis

Standards

Designed to meet EN60950 and corresponding UL & CSA Standards

EMI

EN55022 Class A

Hold-Up Time

Min. 10ms at any input for 5% drop of the output voltage

Switching Frequency

50 - 150KHz Boost section
 50KHz +/- 5KHz DC/DC section

Main Output Voltage/ Current

+32V / 31A
 Adjustable 30-34V
 Output is floating

Auxiliary Output Voltage/Current

+12V +/-0.1V / 3A.
 Negative of this output is connected to COMMON

Redundancy Diode

None

Line/Load Regulation

+/-1% combined from zero load to full load on both outputs

Dynamic Response

Max 5% voltage deviation for 10% to 50% load step, with better than 1msec recovery time on both outputs

Output Ripple/Noise

Better than 50mVrms or 250mVpp (@ 20MHz BW) on the 28V output and 30mVrms or 150mVpp on the 12V output

Output Overload Protection

Rectangular current limiting with short-circuit protection
 Thermal shutdown in case of insufficient airflow (self-resetting)
 Current Limit: 33A +/- 1A on 32V
 4.5A +/- 0.5A on 12V

Output Over-voltage Protection

Second regulator loop, completely stable and independent of main regulator loop
 OVP limit: 36V +/- 1V on 32V
 15V +/- 1V on 12V

Efficiency

min. 80% at full load

Operating Temperature Range

0 to +50 °C for full specification

Temperature Drift

0.03% per °C over operating temperature range

Cooling

By external fan

MTBF

100,000 hours @45 °C

Indicators

None

Control Input

Enable Terminal to be connected to the +12V for operation

Alarm Output

Power Good signal goes low if output fails

Environmental Protection

Basic ruggedization

Package/ Dimensions

5.25" x 4.25" x 14.25".
 See outline drawing

Weight

6.5 lbs. (3kg)

Connections

12 pole Barrier type terminal block with 3/8" spacing

Warranty

Twelve months subject to application within good engineering practice

Drawn by MK	Date May 18, 2006
Checked by	Drawing No / Rev. SCD G099 1000A1
Approved by	

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